

Parker Chomerics CHO-BOND 4041 Part B Conductive Adhesive

Category : Polymer , Adhesive , Thermoset

Material Notes:

Information provided by Chomerics

Order this product through the following link:

http://www.lookpolymers.com/polymer_Parker-Chomerics-CHO-BOND-4041-Part-B-Conductive-Adhesive.php

Physical Properties	Metric	English	Comments
Specific Gravity	>= 1.00 g/cc	>= 1.00 g/cc	

Thermal Properties	Metric	English	Comments
Flash Point	>= 93.3 °C	>= 200 °F	

Component Elements Properties	Metric	English	Comments
Copper, Cu	>= 75 %	>= 75 %	
Silver, Ag	<= 20 %	<= 20 %	

Descriptive Properties	Value	Comments
Color	Silver	
Physical Form	Silver paste mild odor	
Silicone Resin %	<10	

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